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Commissioner for Patents POB 1450, Alexandria, VA 22313-1450 Transmitted to USPTO Central Fax No. 703-872-9306

Re:

K. AOTA, et al, Application No.:10/600,576

Docket No.: 503.35255VX1

Examiner: K. Stoner

SUBMISSION OF DOCUMENTS

Sir:

Applicant hereby transmits the attached "RESPONSE" (7 pp), "Terminal Disclaimer" with copy of Assignment (4 pp) and CREDIT CARD PAYMENT FORM" (1 pg) regarding the above-identified application.

CERTIFICATE OF TRANSMISSION:

I hereby certify that the attached "Response, Terminal Disclaimer (with copy of Assignment) and Credit Card Payment Form" (12 pages) is being FORMALLY TRANSMITTED via the USPTO Central Fax No. 703-872-9306 on March 22, 2005.

William I. Solomon Reg. No. 28,565

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ASSIGNMENT (議 渡 証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI, LTD., a corporation organized under the laws of Japan, located at 6, Kanda Surugadai 4-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI, LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

PANEL STRUCTURE, A FRICTION WELDING METHOD, AND A PANEL

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI, LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI, LTD.

Signed on the date(s) indicated aside signatures:

INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)	Witnesses (立会人サイン)
1) <u>Kinya Rota</u> 2) Jsurjoshi Jakenaka	21, February, 1997	Toshiaki Sagana
2) Toureshi Takenaka	21, February, 1997	Toshiako Sogawa
3) Masus. Ishimam.	21 - February, 1997	Toshiali Sogawa
4)		
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8)		
9)		
10)		

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